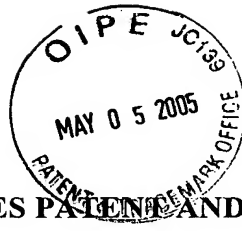


Docket No.: 251148US0



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION: Yuko UCHIMARU, et al.

SERIAL NO.: 10/809,704

GAU: 2812

FILED: March 26, 2004

FOR: LOW DIELECTRIC CONSTANT INSULATING MATERIAL AND SEMICONDUCTOR
DEVICE USING THE MATERIAL

LETTER SUBMITTING REPLACEMENT DRAWING SHEET

COMMISSIONER FOR PATENTS
Alexandria, VA 22313

SIR:

Responsive to the below indicated communication, the following drawing sheets are submitted herewith:

- ☒ 1 Replacement Drawing Sheet ☐ _____ New Drawing Sheets
- ☐ Official Action dated _____
- ☐ Notice of Allowance/Issue Fee dated _____
- ☒ Other Notice to File Corrected Application Papers dated March 22, 2005

The changes and/or modifications made include the following:

The attached Replacement Drawing Sheets for Fig. 24 has been corrected from Japanese to English as requested. Regarding the Notice's objection to Fig. 18, the figure is correct as filed.

Respectfully Submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.
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